

## CALENDAR

## Upcoming: August 26–31, Scientific Basis for Nuclear Waste Management Symposium, MRS.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313.

**MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.**

▼ identifies a new or revised entry this month.

See the May 2000 MRS BULLETIN for July 2000 Calendar entries.

## AUGUST 2000

**1-4** ▼ Intl. Conf. on Superplasticity and Advanced Materials, Orlando, FL. N. Chandra, Dept. of Mechanical Engineering, FAMU-FSU College of Engineering, 2525 Pottsdamer St., Tallahassee, FL 32310; 850-410-6320; fax 850-410-6420; e-mail chandra@eng.fsu.edu.

**3-4** ▼ Conf. on Advances in Applying Integrated Commercial-off-the-Shelf Microelectromechanical Systems, Berkeley, CA. The Knowledge Foundation, 18 Webster St., Brookline, MA 02446; 617-232-7400; fax 617-232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

**6-11** 7th International Symposium on Polymer Electrolytes (ISPE7), Noosa, Queensland, Australia. Astrid Nordmann, ISPE7 Conference Secretariat, Centre for Advanced Materials Technology, Monash University, Wellington Road, Clayton, Victoria, 3168, Australia; 61-3-9905-5791; fax 61-3-9904-4998; e-mail ispe7@eng.monash.edu.au; http://www.chem.monash.edu.au/electrolytes/ispe7/.

**6-11** 16th IUPAC Conf. on Chemical Thermodynamics, concurrent with 55th Calorimetry Conf. and 10th Symposium on Thermodynamics of Nuclear Materials, Halifax, Nova Scotia, Canada. M.A. White, Dept. of Chemistry, Dalhousie Univ., Halifax, Nova Scotia B3H 4J3, Canada; phone and fax 902-494-3894; e-mail icct@is.dal.ca; http://is.dal.ca/~ICCT.

**6-11** Intl. Conf. on Magnetism, Recife, Brazil. S. Rezende; 55-81-281-8450; fax 55-81-271-0359; e-mail smr@df.ufpe.br.

**7-10** 8th Asia Pacific Physics Conf., Taipei, Taiwan. O. Huang, Conf. Secretariat, c/o Inst. of Physics, Academia Sinica, Nankang 115, Taipei, Taiwan; 886-2-27899602; fax 886-2-27829636; e-mail appc2k@phys.sinica.edu.tw.

**9-12** Meeting of the APS Division of Particles and Fields, Columbus, OH. S. Raby; 614-292-3910; e-mail raby@meps.ohio-state.edu; www.dpf2000.org.

**13-16** Nonlinear Optics Topical Meeting, Maui, HI. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**13-17** ▼ Joint Meeting of the American Statistical Assoc., Inst. of Mathematical Statistics, Statistical Society of Canada Intl., and Biometric Society Eastern and Western North America Regions, Indianapolis, IN. American Statistical Assoc., 1429 Duke St., Alexandria, VA 22314-3415; www.amstat.org/meetings/jsm/2000.

**13-18** 12th American Conf. on Crystal Growth and Epitaxy, Vail, CO. T. Gentile, ACCGE-12 Secretariat, P.O. Box 3233, Thousand Oaks, CA 91359-0233; 805-492-7047; fax 805-492-4062; e-mail aacg@lafn.org; www.aml.arizona.edu/aacg.

**15-19** Conf. on Nuclear Structure, East Lansing, MI. S. Conroy; 517-333-6333; e-mail NS2000@nsl.msu.edu; www.nsl.msu.edu/conferences/NS2000.

**16-18** 4th Latin American Colloquium on Fracture and Fatigue, Neuquén, Argentina. Grupo Mecánica de Fractura Facultad de Ingeniería, Univ. Nacional del Comahue, Buenos Aires 1400, (8300) Neuquén, Argentina; 54-299-4490355; e-mail sam@uncoma.edu.ar; www.uncoma.edu.ar/actividades/sam2000.

**16-20** 12th Intl Conf. on Textures of Materials, Montreal, Canada. N. Procyshyn, Dept. of Mining and Metallurgical Engineering, McGill Univ., 3450 University St., Montreal, Quebec, H3A 2A7, Canada; 514-398-4383; fax 514-398-7099; e-mail norma@minmet.lan.mcgill.ca; http://www.icotom12.ica.ca.

**16-22** Jahn Teller Symposium, Boston, MA. M. Kaplan, Simmons College and Boston Univ.; 617-521-2727; e-mail kaplan@buphy.bu.edu.

**20-23** 39th Annual Conf. of Metallurgists, Ottawa, Canada. H. Mostaghaci, Advanced Materials Group, Industry Canada, 235 Queen St., Ottawa, ON K1A 0H5, Canada; 613-954-5012; fax 613-952-4209; e-mail mostaghaci.hamid@ic.gc.ca.

**20-25** 5th Intl. Conf. on Nanostructured Materials, Sendai, Japan. Conf. Secretariat, Nano2000, Inst. for Materials Research, Tohoku Univ., 2-1-1 Katahira, Aoba-ku, Sendai 8577, Japan; 81-22-215-2256; fax 81-22-215-2111; e-mail nano2000@imr.tohoku.ac.jp; http://koho.imr.tohoku.ac.jp/nano-2000/.

**20-25** 17th Intl Conf. on Raman Spectroscopy, Beijing, China. H. Zhou, Secretary General, Dept. of Physics, Peking Univ., Beijing 100871, China; 8610-6275-1750; fax 8610-6275-9117; e-mail icors@pku.edu.cn; http://www.hkics.com/icors2000 or http://www.pku.edu.cn/others/icors/icors.htm.

**20-25** ▼ ACS Symposium on Materials for Transportation, Washington, DC. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**21-23** ▼ Conf. on Photon Correlation and Scattering, Whistler, British Columbia, Canada. Optical Society of America, 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1907; fax 202-416-6140; e-mail custserv@osa.org; www.osa.org/mtg-conf.

**21-25** 13th Intl. Symposium on Exoemission and Related Relaxation Phenomena, Latvia. A. Katashev, EEMT Inst., Riga Technical Univ., 1. Kalku St., Riga LV-1658, Latvia; phone/fax 371-7089383; e-mail katashev@latnet.lv.

**22-26** Ab initio (from Electronic Structure) Calculations of Complex Processes in Materials, Schwaebisch Gmuend, Germany. E-mail psik-coord@daresbury.ac.uk.

**26-30** 15th European Conf. on Atomic and Molecular Physics of Ionized Gases, Miskolc-Lillafured, Hungary. Z. Donko, c/o Eotvos Lorand Physical Society, H-1371 Budapest, P.O. Box 433, Hungary; e-mail escampig@elft.mtesz.hu; http://elft.mtesz.hu/escampig2000.

**26-31 Scientific Basis for Nuclear Waste Management Symposium.** Sydney, Australia. Conference Secretariat, P.O. Box Q894, QVB Post Office, Sydney NSW 1230 Australia; 61 2-9262-4211; fax 6s1 2-9262-4265; e-mail facets@facetmanagement.com.au; https://www.amink.com.au/secure/ansto2000.htm. **MRS.**

**27-30** Intl. Conf. on Spectroscopy of Ultra-Thin Films and Related Systems, Xi'an, P.R. China. Y. Fang, Spectroscopy Lab., Experimental Ctr., Capital Normal Univ., Beijing 100037, P.R. China; e-mail yfang@bnu.edu.cn; fax 8610-6841-6837.

**28-30** ▼ 3rd Intl. Conf. on Polymer-Solvent Complexes and Intercalates, Besancon, France. J.M. Guenet, c/o Eotvos Lorand Physical Society, Inst. Charles Sadron, CNRS UPR 22, 6 rue Boussingault, F-67083 Strasbourg Cedex, France; 33-388-414-000; fax 33-388-414-099; e-mail guenet@ics.u-strasbg.fr; spectro.ujf-grenoble.fr/poly-solv/.

**28-30** Hysteresis, Metastability and Aftereffect HMA-2000, Chicago, IL. E-mail: ygogotsi@tigger.cc.uic.edu; www.uic.edu/orgs/HMA-2000/.

**28-1** Junior EUROMAT European Conf., Lausanne, Switzerland. B. Toelle, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-791-7751; fax 49-69-791-7733; e-mail junior-euromat@dgm.de; www.junior-euromat.fems.org.

**30-2** ▼ Conf. on Surfaces in Biomaterials, Scottsdale, AZ. Surfaces in Biomaterials Foundation, 13355 10th Ave. North, Ste. 108, Minneapolis, MN 55441-5510; 612-512-9103; fax 612-545-0335; www.surfaces.org.

**31-5** EURESCO Conf. on Supramolecular Chemistry: Reactivity and Catalysis in Supramolecular Systems, Urbino, Italy. J. Henkevovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

## SEPTEMBER 2000

**2-7** EURESCO Conf. on Inorganic Chemistry: Design and Properties of Low Nuclearity Metal Complexes, Achievements and Challenges of Organometallic Complexes in Homogeneous Catalysis, San Feliu de Guixols, Spain. J. Henkevovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**3-7** Polycrystalline Semiconductors Conf., St. Malo, France. O. Bonnaud, GMV Univ. of Rennes I, 35042 Rennes Cedex, France; 33-299-286071; fax 33-299-281674; e-mail polyse2000@univ-rennes1.fr.

**3-8** ▼ 11th European Conf. on Diamond-Like Materials, Carbon Nanotubes, Nitrides, and Silicon Carbide, Porto, Portugal. L. Reed, Conf. Secretariat, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843-721; fax 44-1865-843-958; e-mail e.reed@elsevier.co.uk; www.elsevier.com/locate/diamondconf.

**3-8** Congress of Histochemistry and Cytochemistry, York, UK. Royal Microscopical Society, 37/38 St. Clements, Oxford OX4 1AJ, UK; 44-1865-248768; fax 44-1865-791237; e-mail meetings@rms.org.uk; http://www.rms.org.uk.

**4-9** 12th Intl. Conf. on Ion Beam Modification of Materials, Porto Alegre, Brazil. IBMM 2000, Inst. de Fisica, UFRGS, Campus do Vale, Caixa Postal 15051; 91501-970 Porto Alegre/RS, Brazil; 55-51-316-6323; fax 55-51-316-6510; e-mail IBMM2000@if.ufrgs.br.

**4-10** 6th Seminar on Computational Physics, Granada, Spain. J. Marro, Inst. "Carlos I" for Theoretical and Computational Physics, Facultad de Ciencias, Univ. of Granada, 18071-Granada, Spain; fax 34-958-242-862; e-mail cphys@ugr.es; http://ergodic.ugr.es/cp/.

**5-8** ▼ 19th European Conf. on Surface Science, Madrid, Spain. E.G. Michel, Dto. de Fisica de Materia Condensada, Univ. Autonoma de Madrid, 28049 Madrid, Spain; 34-91-397-4759; fax 34-91-397-3961; e-mail ecoss19@uam.es; ecoss.fmc.uam.es/cp/.

**5-19** 2nd Intl. Smakula Symposium: Basic and Applied Problems of Modern Physics, Ternopil, Ukraine. V. Shenderovskiy; Deputy Chairman of the Organizing Committee, Inst. of Physics of the Natl. Academy of Sciences of Ukraine, Kyiv 030039, Ukraine; fax 380-44-265-5671.

**6-9** ACerS Pacific Coast Regional Meeting with Basic Science Div., San Francisco, CA. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.ceramics.org.

**9-14** EuroConference on Atoms and Molecules in Super-Intense Laser Fields, Acquafredda di Maratea, Italy. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**9-15** Intl. Symposium on the Process Metallurgy of Uranium, Saskatoon, Canada. C. Edwards, 306-956-6323; fax 306-956-6533; e-mail chuck\_edwards@cameco.com.

**9-15** Particle Physics and Gravitation: EuroConference on Quantum Fields and Strings, Crete, Greece. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**10-13** ▼ 37th IMAPS Nordic Conf., Helsingør, Denmark. IMAPS Nordic, P.O. Box 277, SE-431 24 Mölndal, Sweden; fax 46-19-56-7070; e-mail info@imapsnordic.a.se; www.imapsnordic.a.se.

**10-14** ACerS Functionally Graded Materials Conf., Estes Park, CO. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.acers.org.

**10-15** Conf. on Lasers and Electro-Optics/Europe, and Intl. Quantum Electronics Conf., Nice, France. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**13-15** 7th Intl. Conf. on Computer Methods in Composite Materials and Structures, Bologna, Italy. Conf. Secretariat CADCOMP 2000, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail wit@wessex.ac.uk; http://www.wessex.ac.uk/conferences/2000.

**13-15** ▼ Conf. on Photomask Technology and Management, Monterey, CA. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**13-15** European Metallographic Conf., Saarbrücken, Germany. P.P. Schepp, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-791-7750; fax 49-69-791-7733; e-mail vdb@dgm.de; www.euromet.dgm.de.

**13-15** Intl. Congress on Extractive Metallurgy and Mineral Processing, Melbourne, Australia. M.F. Marconi, Lev. 13, 15-31 Pelham St., Carlton, Victoria, Australia 3053; 61-3-4662-3166; fax 61-3-4662-3662.

**13-16** 2nd Intl. Conf. on Inorganic Materials, Santa Barbara, CA. S. Wilkinson, 2nd Intl. Conf. on Inorganic Materials, Elsevier Science Ltd., The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843691; fax 44-1865-843958; e-mail sm.wilkinson@elsevier.co.uk; www.elsevier.com/locate/im2000.

**16-21** EURESCO Conf. on Plasticity of Materials, Acquafredda di Maratea, Italy. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**17-21** 9th Intl. Symposium on Superalloys, Champion, PA. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; http://www.tms.org.

**17-22** 13th Intl. Conf. on Ion Implantation Technology, Tyrol, Austria. IIT 2000, c/o IIS-B, Schottkystrasse 10, 91058 Erlangen, Germany; 49-9131-761-100; fax 49-9131-761-102; e-mail iit2000@iis-b.fhg.de; http://www.mfa.kfki.hu/IIT2000.

**17-22** 25th Intl. Conf. on the Physics of Semiconductors, Osaka City, Japan. C. Hamaguchi; 81-6-6879-7765; fax 81-6-6879-7753; e-mail hamaguti@ele.eng.osaka-u.ac.jp; http://mc-net.itbcom.co.jp/icps25.

**17-22** 28th Photovoltaic Specialists Conf., Anchorage, AK. A. Rohatgi, Georgia Inst. of Technology, School of Electrical and Computer Engineering, 777 Atlantic Dr., Atlanta, GA 30332-0250; 404-894-7692; 404-894-5934; e-mail ajreit.rohatgi@ece.gatech.edu; http://ieeepvs@nrel.gov.

**17-22** Applied Superconductivity Conf., Virginia Beach, VA. Courtesy Associates, 2000 L St. NW, Ste. 710, Washington, DC 20036; 202-973-8692; fax 202-331-0111; e-mail asc@courtesyassoc.com.

**18-19** ▼ SPIE Regional Meeting on Optoelectronics, Photonics, and Imaging, Charlotte, NC. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**18-20** 4th Conf. on Aerospace Materials, Processes, and Environmental Technology, Huntsville, AL. J. Weiner, 4th Conf. on Aerospace Materials, Processes, and Environmental Technology, P.O. Box 928, Huntsville, AL 35804; 256-533-5923; e-mail jweiner@aol.com; http://ampet.msfc.nasa.gov.

**18-22** Intl. Conf. on Materials and Coatings for Extreme Environments Performance, Crimee, Ukraine. Organizing Committee "MEE 2000," Inst. for Problems of Materials Science, 3 Krzhizhanovskiy Str., 03142 Kiev, Ukraine; 380-44-444-3231; fax 380-44-444-2131; e-mail chern@materials.kiev.ua.

**19** ▼ Single Chip Packaging Conf., Boston, MA. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

**20-22** ▼ 33rd IMAPS Intl. Symposium on Microelectronics, Boston, MA. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

**21-22** Intl. Activated Carbon Conf., Pittsburgh, PA. B. Sherman, Professional Analytical and Consulting Services, 409 Meade Dr., Coraopolis, PA 15108; 724-457-6576; fax 724-457-1214; e-mail hnpacs@aol.com; members.aol.com/hnpacs/pacs.htm.

**22-24** ▼ IMAPS Advanced Technology Workshop on Chip Scale Packaging, North Falmouth, MA. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

**24-27** ACerS Manufacturing Workshop, Louisville, KY. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.acers.org.

**24-28** Bulk Metallic Glasses, Singapore, United Engineering Foundation Conferences, Three Park Avenue, 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org/engfnd/Oat.html.

**25-27** ▼ Conf. on Permanent Magnet Systems, Atlanta, GA. C. Jones, Gorham Advanced Materials, 211 Mosher Rd., Gorham, ME 04038; 207-892-5445; fax 207-892-2210; e-mail gorham@goradv.com; www.goradv.com.

**25-27** Intl. Conf. on Tungsten and Refractory Metals, Annapolis, MD. Metal Powder Industries Federation; 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpi.org.

**25-28** ▼ Conf. on Interferometry in Speckle Light, Lausanne, Switzerland. Interferometry in Speckle Light, IMAC-EPFL GC-Ecublens, CH-1015 Lausanne, Switzerland; 41-21-693-2444; fax 41-21-693-4748; e-mail IntSL2000.board@epfl.ch.

**25-28** Intl. Congress on Advanced Materials, Their Processes, and Applications, Munich, Germany. Werkstoffwoche-Partnerschaft GBRmbH, Hamburger Allee 26, 60486 Frankfurt, Germany; 49-69-791-7747; fax 49-69-791-7733; e-mail materialsweek@dgm.de; www.materialsweek.org.

**27-28** Intl. Conf. on Magnesium Alloys and Their Applications, Munich, Germany. Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-791-7758; fax 49-69-791-7733; e-mail magnesium@dgm.de; www.magnesium.dgm.de.

**27-30** Worlds in Transition: Technoscience, Citizenship, and Culture in the 21st Century; Conf. of the Society for Social Studies of Science and the European Assoc. for the Study of Science and Technology, Vienna, Austria. U. Felt, Prof. of Social Studies of Science, Dept. of Philosophy of Science and Social Studies of Science, Univ. of Vienna, Sensengasse 8/10, A-1090 Vienna, Austria; 43-1-4277-47611; fax 43-1-4277-9476; e-mail 4SEASST@univie.ac.at; www.univie.ac.at/wissenschaftstheorie/.

**29-30** Fall Meeting of APS Four Corners Section, Ft. Collins, CO. H.D. Hochheimer, Dept. of Physics, Colorado State Univ., Ft. Collins, CO 80523; 970-491-6246; fax 970-491-7947; e-mail aps4cs@lamar.colostate.edu; http://lamar.colostate.edu/\_aps4cs/.

**30-5** EURESCO Conf. on Surface Engineering for Protection of Metals and Alloys, Acquafredda di Maratea, Italy. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

## OCTOBER 2000

**1-4** Brimacombe Memorial Symposium, Vancouver, Canada. I. Samarasekera, Advanced Materials and Processing Engineering Lab., Univ. of British Columbia, Rm. 111-2355 East Mall, Vancouver, BC, Canada V6T 1Z4; 604-822-3668; fax 604-822-2965; e-mail indirac@cmpe.ubc.ca.

**1-4** ACerS Glass and Optical Materials Division Fall Meeting, Corning, NY. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.acers.org.

**2-6** AVS 47th Intl. Symposium, Boston, MA. American Vacuum Society, 120 Wall St., 32nd Floor, New York, NY 10005-3993; 212-248-0200; fax 212-248-0245; e-mail avsnyc@vacuum.org; http://www.vacuum.org.

**3-5** Advanced Metallization Conference (AMC) 2000, San Diego, California. 510-642-4151; fax 510-642-6027; e-mail course@unx.berkeley.edu.

**4-7** Meeting of the APS Division of Nuclear Physics, Williamsburg, VA. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**7-12** EURESCO Conf. on Fundamental Aspects of Epitaxial Growth, Castelvecchio Pascoli, Italy. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**8-11** ACeRS Electronics Division Fall Meeting, Clemson, SC. Customer Service Dept., The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.acers.org.

**8-12** TMS Fall Meeting, St. Louis, MO. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; http://www.tms.org.

**11-13** 14th Intl. Conf. on Optical Fiber Sensors, Venice, Italy. A. Grazia Mignani, IROE-CNR, Optics and Photonics Dept., Via Panciatichi 64, I-50127 Firenze, Italy; 39-55-4235-262; fax 39-55-4379-569; e-mail mignani@iroe.fi.cnr.it.

**11-15** Intl. Symposium on Small Particles and Inorganic Clusters, Atlanta, GA. K. Mims, Georgia Inst. of Technology, P.O. Box 93686, Atlanta, GA 30377-0686; 404-385-0383; e-mail CNNGT@mse.gatech.edu; www.conted.gatech.edu/programs/.

**13-14** APS Ohio Section Fall Meeting, Toledo, OH. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

**14-16** 13th Intl. Symposium on Superconductivity, Tokyo, Japan. M. Yoshida, ISS 2000 Secretariat, ISTE, Shinbashi 5-34-3, Minato-ku, Tokyo 105-0004, Japan; fax 81-3-3431-4044; e-mail joschda@istec.or.jp; www.istec.or.jp.

**14-19** EuroConference on Quantum Optics, Mallorca, Spain. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**16-17** 3rd Intl. Conf. on Materials for Microelectronics, Dublin, Ireland. C. Pearcey, Conf. & Events, (CO19) IOM Communications Ltd., 1 Carlton House Terrace, London SW1Y 5DB, UK; 44-207-451-7340; fax 44-207-839-2289; e-mail Cathy\_Pearcey@materials.co.uk; www.materials.org.uk.

**16-18** Annual Symposium on Optical Materials for High Power Lasers, Boulder, CO. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**16-18** Georgia Tech Conf. on Nanoscience and Nanotechnology, Atlanta, GA. Georgia Inst. of Technology, P.O. Box 93686, Atlanta, GA 30377-0686; 404-385-3501; fax 404-894-8925; e-mail conted@gatech.edu; www.conted.gatech.edu/programs/.

**16-21** 14th Intl. Spin Physics Symposium, Osaka, Japan. T. Nakano, RCNP, Osaka Univ., Mihogaoka 10-1, Ibaraki, Osaka 567-0047, Japan; 81-6-6879-8938; fax 81-6-6879-8899; e-mail spin2000@rcnp.osaka-u.ac.jp; www.rcnp.osaka-u.ac.jp/spin2000.

**18-20** European Powder Metallurgy Assoc. Conf., Munich, Germany. European Powder Metallurgy Assoc., Old Bank Bldgs., Bellstone, Shrewsbury SY1 1HU, UK; 44-1743-248899; fax 44-1743-362968; e-mail info@epma.com; www.epma.com.

**19-21** 16th Meeting of the Academy of Surgical Research, Cincinnati, OH. Academy of Surgical Research, 13355 10th Ave. North, Ste. 108, Minneapolis, MN 55441-5510; 612-545-1919; fax 612-545-0335; www.surgicalresearch.org.

**19-24** EURESCO Conf. on High Performance Fibers, Palma de Mallorca, Spain. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-767135; fax 33-388-366987; e-mail euresco@esf.org; www.esf.org/euresco.

**20-21** 2nd Intl. Symposium on Designing, Processing, and Properties of Advanced Engineering Materials, Guilin, P.R. China. R. Yang, ISAEM Secretariat, Inst. of Metal Research, 72 Wenhua Rd., Shenyang 110015, P.R. China; 86-24-2384-3531-55781; fax 86-24-2389-1320; e-mail ryang@pub.sy.in.cn; www.imr.ac.cn/ISAEM-2000.html.

**20-28** OSA Annual Meeting, Providence, RI. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; http://www.osa.org/mtg-conf.

**22-25** TMS Fall Extraction and Process Metallurgy Meeting, Pittsburgh, PA. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; http://www.tms.org/cms.

**22-26** Optical Networking and Communications Conf., Richardson, TX. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**22-27** 198th Meeting of The Electrochemical Society, Phoenix, AZ. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; http://www.electrochem.org/meetings/.

**23-27** Meeting of the APS Division of Plasma Physics, Quebec, Canada. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**24-27** 53rd Annual Gaseous Electronics Conf., Houston, TX. D. Economou, Univ. of Houston, Dept. of Chemical Engineering, 4800 Calhoun Rd., Houston, TX 77204-4792; 713-743-4320; fax 713-743-4323; e-mail economou@uh.edu; www.chee.uh.edu.

**25-28** ACS Midwest Regional Meeting, St. Louis, MO. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**25-28** ACS Western Regional Meeting, San Francisco, CA. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**27-28** SRC Annual Users Meeting and Workshop on Atomic and Molecular Physics, Stoughton, WI. R. Wehlitz, Synchrotron Radiation Ctr., 3731 Schneider Dr., Stoughton, WI 53589; 608-877-2134; fax 608-877-2001; e-mail wehlitz@src.wisc.edu.

**28-29** Joint Fall Meeting of the Texas Sections of APS, AAPT, and Zone 13 of the SPS, Houston, TX. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

**29-31** 3rd BCC Conf. on Fine, Ultrafine, and Nano Powders, Montreal, Quebec, Canada. S. Faust, Conf. Coordinator, Business Communications Co., 25 Van Zant St., Norwalk, CT 06855; 203-853-4266; fax 203-853-0348; e-mail buscomm1@aol.com; www.buscom.com.

**29-2** 3rd Intl. Conf. on Coatings on Glass, Maastricht, The Netherlands. 3rd-ICCG, Kongresservice Brabant, P.O. Box 141, 5500 AC Veldhoven, The Netherlands; 31-40-254-7171; fax 31-40-254-6566; e-mail 3rd-iccg@tpd.tno.nl; www.tpd.tno.nl/3rd-iccg.

**29-2** 15th Annual Natl. Educators' Workshop, Kettering, OH. Natl. Educators' Workshop: Update 2000, School of Science and Technology, Norfolk State Univ., 700 Park Ave., Norfolk, VA 23504-8060; 757-823-8109; fax 757-823-8215; e-mail dplaclaire@nsu.edu.

**29-3** MCS/ACeRS Manufacturing Workshop, Monterrey, Mexico. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrvc@acers.org; www.ceramics.org.

**30-2** 4th Intl. Conf. on High-Strength Low-Alloy Steels, Xi'an, China. HSLA Steels 2000 Secretariat, CSM, 46 Dongsixi Dajie, Beijing, China 100711; 86-10-6513-3925; fax 86-10-6512-4122; e-mail csm@public.bta.net.cn.

**30-2** 2000 U.S. Workshop on the Physics and Chemistry of II-VI Materials, Albuquerque, NM. Laura Manganiello, Palisades Institute for Research Services, Inc., 411 Lafayette Street, 2nd Floor, New York, NY 10003; 212-460-8090; x206; fax 212-460-5460; www.ii-viworkshop.org.

## NOVEMBER 2000

**1-4** 16th Intl. Conf. on the Application of Accelerators in Research and Industry, Denton, TX. J. Duggan; 940-565-3252; e-mail stippec@unt.edu; www.phys.unt.edu/accelcon/.

**2-4** Meeting of the APS Southeastern Section, Starkville, MS. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**3-8** Photonics East Conf., Boston, MA. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**5-8** 2nd Intl. Conf. on Processing Materials for Properties, San Francisco, CA. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail csc@tms.org; http://www.tms.org/cms.

**5-8** 6th Biennial Conf. on Organic Coatings, Hilton Head Island, SC. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail narc@ims-np.org; www.ims-np.org/.

**6-8** 14th Intl. Conf. and Workshops on Applied Geologic Remote Sensing, Las Vegas, NV. Veridian-ERIM Intl., P.O. Box 134008, Ann Arbor, MI 48113-4008; 734-994-1200; fax 734-994-5123; www.erim-int.com/conf/conf.html.

**8-9** Intl. Conf. on Material Science and Technologies, Jerusalem, Israel. AGIL Conf. Seridian-ERIM Intl., P.O. Box 134008, Ann Arbor, MI 48113-4008; 734-994-1200; fax 734-994-5123; www.ersoft.co.il/agil.htm.

**8-10** 3rd Biennial Conf. on Polymer Stabilizers and Modifiers, Hilton Head Island, SC. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail narc@ims-np.org; www.ims-np.org/.

**11-15** Intl. Conf. on Elementary Processes in Molecule-Metal Surface Interactions, San Juan, Puerto Rico. E. Rivera, Conf. Coordinator, Resource Ctr. for Science and Engineering, P.O. Box 23334, San Juan, PR 00931-3334; 787-764-8369; 787-756-7717; e-mail evelyn@adam.uprr.pr; web.uprr.pr/icep/.

**12-17** AIChE Annual Meeting, Los Angeles, CA. AIChE, 3 Park Ave., New York, NY 10016; http://www.aiche.org.

**13-14** ASTM Symposium on Marine Corrosion in Tropical Environments, Merida, Yucatan, Mexico. V. Chaker, Port Authority of NY-NJ, One World Trade Ctr., 74W, New York, NY 10048; 212-435-5790; fax 212-435-8040.

**13-15** Intl. Conf. on Continuous Casting, Frankfurt, Germany. A. Tinnemans, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-791-7758; 49-69-791-7733; e-mail at@dgm.de; www.dgm.de.

**15-16** ASTM Symposium on Mechanical Properties of Structural Films, Orlando, FL. ASTM Symposia Operations, 100 Barr Harbor Dr., West Conshohocken, PA 19428-2959; 610-832-9677; www.astm.org.

**19-21** Meeting of the APS Division of Fluid Dynamics, Washington, DC. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**19-22** 3rd Intl. Conf. on High-Temperature Capillarity, Kurashiki, Japan. K. Nogi, Joining and Welding Research Inst., Osaka Univ., 11-1 Mihogaoka, Ibaraki, Osaka, Japan; phone and fax 81-6-6879-8643; e-mail nogisan@jwri.osaka-u.ac.jp.

**19-23** 1st Intl. Conf. on Advanced Materials Processing, Rotorua, New Zealand. D. Zhang, Dept. of Mat. and Proc. Engineering, Univ. of Waikato, Private Bag 3105, Hamilton, New Zealand, fax 64-7-838-4835; e-mail d.zhang@waikato.ac.nz.

**20-22** Intl. Symposium on Fuel Cells for Vehicles, Nagoya, Japan. Y. Takeda, Dept. of Chemistry, Faculty of Engineering, Mie Univ., Kamihama, Tsu 514-8507, Japan; 81-59-231-9419; fax 81-59-231-9478; e-mail takeda@chem.mie-u.ac.jp; http://elech.kuic.kyoto-u.ac.jp:8080/~dengji/.

**21-24** 7th NCB Intl. Seminar on Cement and Building Materials, New Delhi, India. Organizing Secretary, 7th NCB Intl. Seminar, Natl. Council for Cement and Building Materials, P-21 South Extension 11, Post Box No. 3885, New Delhi 110049, India; 91-129-242051-56; fax 91-129-242100; e-mail nccbm@giasdl01.vsnl.net.in.

**27-1** 4th Intl. Conf. on Monte Carlo and Quasi-Monte Carlo Methods in Scientific Computing, Hong Kong. Statistics Research and Consultancy Unit, Hong Kong Baptist Univ., Kowloon Tong, Hong Kong; e-mail mcqmc2000@www.mcqmc.org; www.mcqmc.org/MCQMC2000.html.

**27-1** **MRS Fall Meeting**, Boston, MA. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; http://www.mrs.org/. **MRS.**

## DECEMBER 2000

**3-5** 18th Annual Membrane Technology/Separations Planning Conf., Newton, MA. Business Communications Co., 25 Van Zant St., Norwalk, CT 06855; 203-853-4266; fax 203-853-0348; e-mail buscomm1@aol.com; www.buscom.com.

**3-6** 3rd Workshop on Polymeric Materials for Microelectronics and Photonics Applications, London, UK. E. Suhir, Lucent Technologies, 600 Mountain Ave., Rm. 1D-443, Murray Hill, NJ 07974; 908-582-5301; fax 908-582-5106; e-mail suhir@lucent.com. **Endorsed.**

**4-8** Intl. Conf. on Processing and Manufacturing of Advanced Materials, Las Vegas, NV. T. Chandra, Univ. of Wollongong, Dept. of Materials Engineering, Northfields Ave., Wollongong NSW 2522, Australia; 61-42-21-3008; fax 61-42-21-3112; e-mail t.chandra@uow.edu.au.

**6-8** ACS Southeast/Southwest Regional Meeting, New Orleans, LA. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

## JANUARY 2001

**6-11** AAPT and AAS Joint Winter Meeting, San Diego, CA. AAPT Meetings Dept., One Physics Ellipse, College Park, MD 20740; e-mail aapt-meet@aapt.org; www.aapt.org.

**7-10** Workshop on Nanostructured Materials Made from Self-Assembled Molecules and Particles, Hindas, Sweden. A. Palmqvist, Chalmers University of Technology, SE-412 96 Goeteborg, Sweden; fax 46-31-7722967; e-mail anders.palmqvist@surfchem.chalmers.se; www.kck.chalmers.se.

**8-10** PLASTEC™ West Plastics Conf., co-located with Medical Design & Manufacturing and Pacific Design & Manufacturing Conf., Anaheim, CA. Canon Communications, 11444 W. Olympic Blvd., Ste. 900, Los Angeles, CA 90064; 310-996-9447; 310-996-9499; www.canontradeshows.com.

**20-26** Photonics West Conf., San Jose, CA. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**21-26** 25th Intl. Conf. on Advanced Ceramics and Composites, Cocoa Beach, FL. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org/meetings/.

**28-31** Microtech Conf., West London, UK. Intl. Microelectronics and Packaging Society, 1850 Centennial Park Dr., Ste. 105, Reston, VA 20191-1517; 703-758-1060; fax 703-758-1066; e-mail imaps@imaps.org; www.imaps.org.

## FEBRUARY 2001

**5-7** IEEE Intl. Solid-State Circuits Conf., San Francisco, CA. D. Suiters, 202-331-2000; e-mail isscc@courtesyassoc.com.

**5-9** Advanced Research Workshop on Semiconductor Nanostructures, Blenheim, New Zealand. D.J. Lockwood, Inst. for Microstructural Sciences, Natl. Research Council of Canada, 1191 Montreal Rd., Bldg. M-36, Ottawa, Ontario, Canada K1A 0R6; 613-993-9614; fax 613-993-6486; e-mail david.lockwood@nrc.ca.

**11-15** TMS Annual Meeting, New Orleans, LA. Customer Service, TMS, 184 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; http://www.tms.org/cms.

**19-22** 4th Industrial Energy Efficiency Symposium, Washington, DC. Office of Industrial Technologies, EE-20, U.S. Dept. of Energy, 1000 Independence Ave., S.W., Washington, DC 20585; www.oitexpo4.com.

## MARCH 2001

**5-8** Intl. Laser Safety Conf., San Diego, CA. Laser Inst. of America, 13501 Ingenuity Dr., Ste. 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail lia@laserinstitute.org; www.laserinstitute.org.

**11-15** 10th Biennial Workshop on Organometallic Vapor Phase Epitaxy, San Diego, CA. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

**12-16** APS March Meeting, Seattle, WA. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**25-30** 199th Meeting of the Electrochemical Society, Washington, DC. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; http://www.electrochem.org/meetings/. **Symposium Endorsed.**

## APRIL 2001

**16-20** **MRS Spring Meeting**, San Francisco, CA. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; http://www.mrs.org. **MRS.**

**20-26** 44th SVC Conf., Philadelphia, PA. Society of Vacuum Coaters, 71 Pinon Hill Place, N.E., Albuquerque, NM 87122-1914; 505-856-7188; 505-856-6716; e-mail svcinfo@svc.org.

**22-25** Conf. on Materials and Science in Sports, Coronado, CA. F.H. Froes, Univ. of Idaho, Inst. of Materials and Advanced Proc., Mines Bldg., Rm. 321, Moscow, ID 83844-3026; 208-885-7989; fax 208-885-4009; e-mail imap@uidaho.edu.

**22-26** 13th Intl. Conf. on Wear of Materials, Vancouver, British Columbia, Canada. A. Hill, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1993-843-643; fax 44-1993-843-958; e-mail a.richardson@elsevier.co.uk; www.elsevier.com.

**22-26** AICe Spring National Meeting, Houston, TX. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

**23-27** APS April Meeting, Washington, DC. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

## MAY 2001

**6-11** Conf. on Lasers and Electro-Optics, and Quantum Electronics and Laser Science Conf., Baltimore, MD. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., N.W., Washington, DC 20036-1023; 202-416-1980; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org/mtg\_conf.

**16-25** Sikkim Intl. Nanotribology Symposium, Sikkim, India. S.K. Biswas, Dept. Mechanical Engineering, Indian Institute of Science, Bangalore 560012, India; 91-80-3600586/3092963; fax 91-80-3600648; nanosikkim@mecheng.iisc.ernet.in; www.mecheng.iisc.ernet.in/nanosikkim.html.

**23-25** 4th Intl. Conf. on Marine Technology, Szczecin, Poland. K. Savage, Wessex Inst. of Technology, WIT Marketing Coordinator, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK; 44-238-029-3223; fax 44-238-029-2853; e-mail ksavage@wessex.ac.uk.

## JUNE 2001

**5-7** PLASTEC™ East Plastics Conf., co-located with Medical Design & Manufacturing East and Atlantic Design & Manufacturing Conf., New York, NY. Canon Communications, 11444 W. Olympic Blvd., Ste. 900, Los Angeles, CA 90064; 310-996-9447; 310-996-9499; www.canontradeshows.com.

**10-13** 75th Colloid and Surface Science Symposium, Pittsburgh, PA. S. Garoff, 412-268-6877; fax 412-681-0648; e-mail sg2e@andrew.cmu.edu.

**10-14** EUROMAT 2001 Conf., Rome, Italy. AIM, Piazzale Rodolfo Morandi 2-1-20121 Milano, Italy; 39-2-7639-7770; fax 39-2-7602-0551; e-mail aim@fast.mi.it; www.fast.mi.it/aim/euromat.htm.

**17-20** 5th Intl. Special Emphasis Symposium on Superalloys 718, 625, 706, and Derivatives, Pittsburgh, PA. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

**23-30** 12th APS Topical Conf. on Shock Compression of Condensed Matter, Atlanta, GA. A. Roach, Los Alamos Natl. Lab.; 505-665-6277; e-mail alita@lanl.gov.

**27-29** Electronic Materials Conf., Notre Dame, IN. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

## JULY 2001

**16-20** 4th Intl. Conf. on Nitride Semiconductors (ICNS-4), Denver, CO. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org. **MRS.**

**16-20** Cryogenic Engineering Conference & International Cryogenic Materials Conference (CEC-ICMC), Madison, WI. Centennial Conferences, 4800 Baseline Road, A-112, Boulder, CO 80303 USA; 303-499-2299; fax 303-499-2599; e-mail cec-icmc@centennialconferences.com; www.cec-icmc.org

**23-27** 13th Intl. Conf. on Vacuum UV Radiation Physics, Trieste, Italy. e-mail renato.gioppo@elettra.trieste.it; vuv13.elettra.trieste.it/vuv13/.

**29-3** 19th Intl. Conf. on Atomic Collisions in Solids, Paris, France. V.A. Esaulov, Lab. des Collisions Atomiques et Moleculaires, Bat. 351, Univ. de Paris Sud, 91405 Orsay Cedex, France; 33-69-15-76-80; fax 33-69-15-76-71; e-mail icacs19@veof1.lcam.u-psud.fr; http://veof1.lcam.u-psud.fr/idc/icacs19.html.

**29-3** SPIE Annual Meeting and Intl. Symposium on Optical Science and Technology, San Diego, CA. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**30-3** 4th Intl Conf. on Biological Physics, Kyoto, Japan. M. Go, Div. of Biological Science, Graduate School of Science, Nagoya Univ., Furo-cho, Chikusa-ku, Nagoya 464-8602, Japan; e-mail icbp2001@kokusai.phys.nagoya-u.ac.jp; kokusai.phys.nagoya-u.ac.jp/.

## AUGUST 2001

**12-17** 10th Intl. Conf. on Phonon Scattering in Condensed Matter, Hanover, NH. Phonons 2001, Dept. of Physics and Astronomy, Dartmouth College, HB 6127, Hanover, NH 03755; e-mail phonons@mac.dartmouth.edu; www.dartmouth.edu/~phonon.

**26-31** 13th European Conference on Chemical Vapor Deposition (EUROCV13), Athens, Greece. Web site www.imel.demokritos.gr/EUROCV D/Eurocvd13.html.

**27-31** Conf. on Recrystallization and Grain Growth, Aachen, Germany. D.A. Molodov, Inst. für Metallkunde und Metallphysik, RWTH Aachen, D-52056 Aachen, Germany; fax 49-241-888-8608; e-mail ReX&GG@imm.rth-aachen.de.

## SEPTEMBER 2001

**2-7** 200th Meeting of the Electrochemical Society and 52nd Meeting of the Intl. Society of Electrochemistry, San Francisco, CA. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

**16-21** Intl. Conf. on Hydrogen Effects on Material Behavior and Corrosion Deformation Interactions, Moran, WY. N.R. Moody, SNL, P.O. Box 969, MS-9404, Livermore, CA 94551; 925-294-2622; fax 925-294-3410. **Endorsed.**

**18-21** Intl. Conf. on Advances in Materials and Processing Technologies, Madrid, Spain. AMPT'01 Congress Secretariat, Fundación Univ. Carlos III, CON-GREGA, Avda. de la Universidad 30, 28911 Leganés, Spain; 34-91-624-9142; fax 34-91-624-9147; e-mail congrega@fund.uc3m.es; e-mail ampt01@ing.uc3m.es.

**23-26** TMS Fall Extraction and Process Metallurgy Meeting, San Diego, CA. M. Cross, School of Computing and Mathematical Science, Univ. of Greenwich, Woolwich Campus, Wellington St., Woolwich, London SE18 6PF, UK; 44-208-331-8702; fax 44-208-331-8695.

**23-27** 3rd Intl. Symposium on Structural Intermetallics, Jackson Hole, WY. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

**23-27** 6th World Congress of Chemical Engineering, Melbourne, Australia. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

**23-27** ACS Southeast Regional Meeting, Savannah, GA. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

## OCTOBER 2001

**3-5** Conf. on Photomask Technology and Management, Monterey, CA. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**10-13** ACS Midwest Regional Meeting, Lincoln, NE. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**17-20** ACS Southwest Regional Meeting, San Antonio, TX. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**28-31** ACS Western Regional Meeting, Santa Barbara, CA. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**29-2** Meeting of the APS Div. of Plasma Physics, Long Beach, CA. APS Headquarters, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

## NOVEMBER 2001

**4-8** Intl. Conf. on Advanced Ceramics and Glasses, Maui, HI. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org/meetings/.

**4-8** TMS Fall Meeting, Indianapolis, IN. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail weissp@tms.org; www.tms.org.

**4-9** AIChE Annual Meeting, Reno, NV. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

**26-30** MRS Fall Meeting, Boston, MA. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; www.mrs.org. **MRS.**

## DECEMBER 2001

**3-7** 10th Intl. Congress of Fracture, Honolulu, HI. A. Hill, ICF10 Congress Secretariat, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843-643; fax 44-1865-843-958; e-mail a.richardson@elsevier.co.uk; www.elsevier.com.

**11-15** 4th Pacific Rim Intl. Conf. on Advanced Materials and Processing, Honolulu, HI. S. Hanada, Tohoku Univ., Inst. for Materials Research, Katahira 2-1-1, Aoba-ku, Sendai 980-8577, Japan; 81-22-215-2115; fax 81-22-215-2116; e-mail ccpricm4@imr.tohoku.ac.jp. □

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